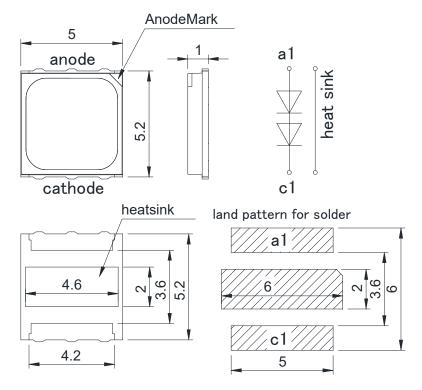


Data Sheet

SMBB760D-2100S-I

760nm High Power TOP LED

Outline and Internal Circuit



(Unit : mm)

Features

- Chip Material : AlGaInP
- Chip Dimension : 1000um * 1000um
- Number of Chips : 2pcs
- Peak Wavelength : 760nm typ.
- Lead Frame Die : Silver Plated on Copper
- Package Resin : PA9T
- Lens : Silicone Resin

Marubeni

Absolute Maximum Ratings (Tc=25°C)

Item	Symbol	Ratings	Unit
Power Dissipation	PD	4000	mW
Forward Current	lF	800	mA
Pulse Forward Current	IFP	2000	mA
Reverse Voltage	VR	10	V
Thermal Resistance	Rthja	10	K/W
Junction Temperature	Tj	120	°C
Operating Temperature	Topr	-40 ~ +100	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Soldering Temperature	TSOL	250	°C

‡Pulse Forward Current condition : Duty 1% and Pulse Width=10us.

‡Soldering condition : Soldering condition must be completed with 5 seconds at 250°C.

Optical and Electrical Characteristics (Tc=25°C)

Parameter	Symbol	Min	Тур	Мах	Unit	Test Condition
Forward Voltage	VF		4.0	5.0	V	IF=800mA
	VFP		5.0			IFP=2A
Total Radiated Power	PO		800		mW	IF=800mA
			2000			IFP=2A
Peak Wavelength	λρ	750		770	nm	IF=800mA
Half Width	Δλ		25		nm	IF=800mA
Rise Time	tr		50		ns	IF=800mA
Fall Time	tf		100		ns	IF=800mA

‡ Radiated Power is measured by S3584-08.



Relative Radiant Intensity -Forward Current - Forward Voltage **Forward Current** 10 (ta=25°C, tw=10µs, Duty=1%) (ta=25°C, tw=10µs, Duty=1%) Relative Radiant Intensity (A.U.) 800mA Standard 10³ 1 0.1 10² 0.01 10¹ 0.001 10⁰ 0.0001 2.0 2.5 3.0 3.5 4.0 4.5 5.0 5.5 6.0 10 100 1 Forward Voltage (V) Forward Current (mA) Allowable Forward Current -Forward Current - Pulse Duration **Ambient Temperature** 1000 Rthja=10K/W 900 800 700 600

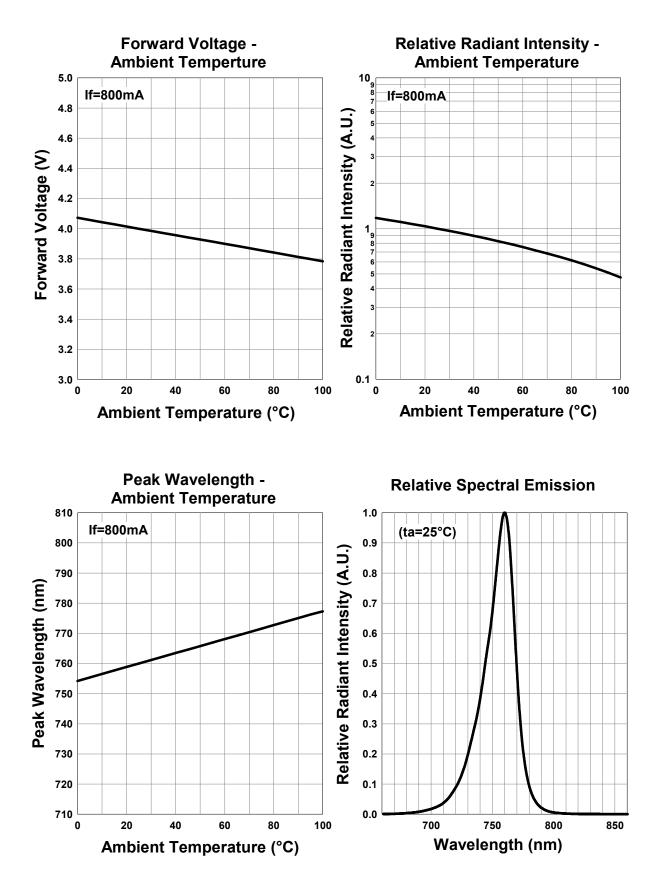
1000

Forward Current (mA)

Allowable Forward Current(mA) Forward Current Ifp [mA] 10³ 500 400 300 200 **OkHz** 100 100Hz 10Hz 1KHz 10² 0 10⁰ 10² 10⁵ 10⁶ 0 20 40 60 80 100 10³ 10⁴ 10¹ Ambient Temperature (°C) Duration tw [µs]

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Wrapping

Moisture barrier bag aluminum laminated film with a desiccant to keep out the moisture absorption during the transportation and storage.

SMD LED storage and handling precautions Storage Conditions before Opening a Moisture-Barrier Aluminum Bag

- Before opening a moisture-barrier aluminum bag, please store it at <30°C, <60%
- RH. Please note that the maximum shelf life is 12 months under these conditions.

Storage Conditions after Opening a Moisture-Barrier Aluminum Bag

- After opening a moisture-barrier aluminum bag, store the aluminum bag and silica gel in a desiccator.
- After opening the bag, please solder the LEDs within 72 hours in a room with 5 30°C, <50%RH.
- Please put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.
- The 72-hour- long floor life does not include the time while LEDs are stored in the moisture-barrier aluminum bag. However, we strongly recommend to solder the LEDs as soon as possible after opening the aluminum bag

Notes about Re-sealing a Moisture-Barrier Aluminum Bag

 When vacuum-sealing an opened aluminum bag, if you find the moisture-indicator of the silica gel has changed to pink from blue (indicating a relative humidity of 30 % or more), please do not use the unused LEDs, the aluminum bag, or the silica gel.

Notes about Opening a Re-sealed Moisture-Barrier Aluminum Bag

 When opening a vacuumed and re-sealed aluminum bag in order to use the remaining LEDs stored in the bag, if you find that the moisture-indicator of the silica has changed to pink, please do not use the LEDs.



Disclaimer

Product specifications and data shown in this product catalog are subject to change without notice for the purposes of improving product performance, reliability, design, or otherwise.

Product data and parameters in this catalog are typical values based on reasonably up-to-date measurements. Product data and parameters may vary by user application and over time.

Products shown in this catalog are intended to be used for general electronic equipment. Products are not guaranteed for applications where product malfunction or failure may cause personal injury or death, including but not limited to life-supporting / saving devices, medical devices, safety devices, airplanes, aerospace equipment, automobiles, traffic control systems, and nuclear reactor control systems.



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